L Number	Hits	Search Text	DB	Time stamp
- Number	7	polishing adj pad and duro	USPAT;	2004/08/02
-	193	polishing adj pad and durometer	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/02 19:38
_	67	polishing adj pad same durometer	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/02 19:24
_	19	(polishing adj pad and durometer) and pore	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/02 19:24
-	66	(polishing adj pad) near7 micron	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/02 19:50
_	608	(polishing adj pad) near7 thickness	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/02 20:02
_	535	(polishing adj pad) near5 thickness	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/02
-	370	(polishing adj pad) near3 thickness	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/02 19:50
-	301	(polishing adj pad) near2 thickness	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/02 19:51
-	195	(polishing adj pad) near thickness	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/02
_	101	(polishing adj pad) near7 thickness near2 layer	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/02 19:51
-	16	((polishing adj pad) near7 thickness) and adhesive adj tape	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/02 20:03